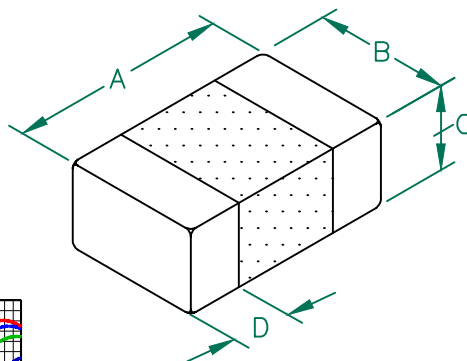


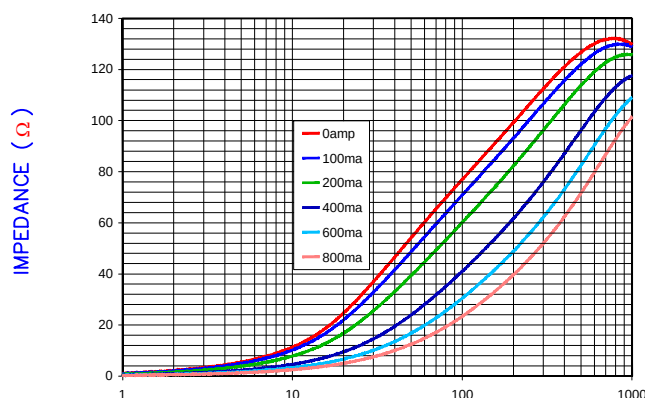
LI0805H750R-10

PHYSICAL DIMENSIONS:

A	2.00 [.079]	$\pm$ 0.20 [.008]
B	1.25 [.049]	$\pm$ 0.20 [.008]
C	0.90 [.035]	$\pm$ 0.20 [.008]
D	0.51 [.020]	$\pm$ 0.25 [.010]

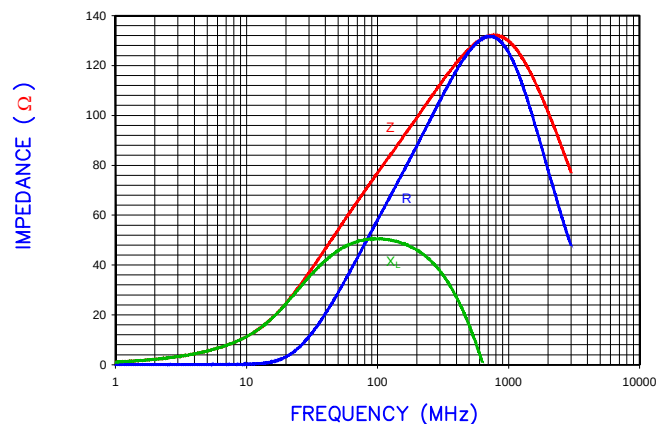


Z vs FREQUENCY
IMPEDANCE UNDER DC BIAS



FREQUENCY (MHz)

|Z|, R, AND X vs. FREQUENCY



FREQUENCY (MHz)

Z

R

X_L

AGILENT E4991A RF Impedance/Material Analyzer
HP 16194A Test Fixture. TEST REF. 3235

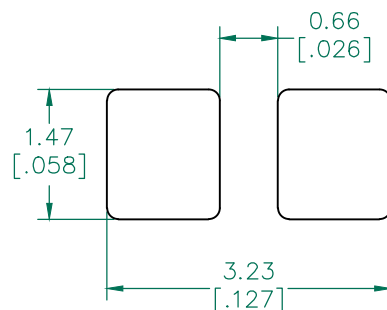
ELECTRICAL CHARACTERISTICS:

	Z @ 100MHz (Ω)	DCR (Ω)	Rated Current
Nominal	75		
Minimum	56		
Maximum	94	0.15	800 mA

NOTES: UNLESS OTHERWISE SPECIFIED

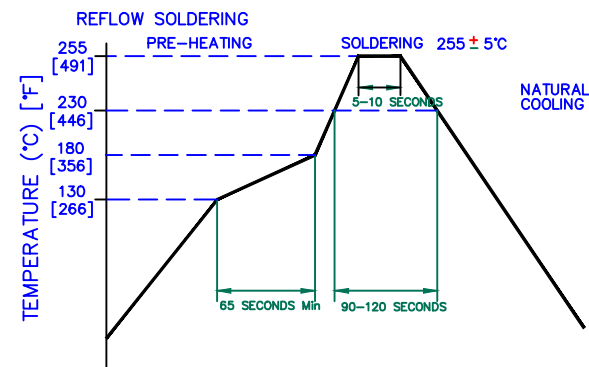
1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL, PAPER TAPE.
2. TERMINATION FINISH IS 100% TIN.
3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)
5. COSMETIC SPECIFICATION REFER TO WI-QA-124.

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [.030] to this dimension.)

RECOMMENDED SOLDERING CONDITIONS



RoHS

DIMENSIONS ARE IN mm [INCHES]				This print is the property of Laird Tech. and is loaned in confidence subject to return upon request and with the understanding that no copies shall be made without the written consent of Laird Tech. All rights to design or invention are reserved.			
D	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	PROJECT/PART NUMBER: LI0805H750R-10			
C	CHANGE TO PAPER TAPE	03/04/10	JUN				
B	UPDATE COMPANY LOGO ADD ROHS SYM	07/21/08	JRK	DATE:	04/05/04	SCALE:	NTS
A	ORIGINAL DRAFT	04/05/04	TMB	CAD #	LI0805H750R-10-D	TOOL #	-
REV	DESCRIPTION	DATE	INT	SHEET: 1 of 1			

Laird

REV D PART TYPE: CO-FIRE DRAWN BY: TMB

Mouser Electronics

Authorized Distributor

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[LI0805H750R-10](#)